

Where

d_{31} is the piezo strain coefficient

E_{el} - electrical field

h_p, h_m - thickness of PVDF film, nickel alloy and total beam

E_p, E_m - Young's modulus of the PVDF film and nickel alloy respectively

I_p, I_m - moment of inertia of these layers

The tip deflection δ can be obtained by

$$k = \frac{\partial^2 \delta}{\partial \chi^2}$$

Coventorware was used to obtain a numerical solution for the piezo cantilever. The materials and parameters of beam are optimised as above by using finite analysis modelling and simulation. The tip deflection of the designed beam is $71.8\mu\text{m}$.

4 Fabrication of PVDF cantilever

Even though PVDF can potentially be used in many microactuator applications, it is still a challenge for MEMS researchers to shape and form these kinds of polymers into a required shape and size. This work demonstrates a novel route for this purpose using laser micromachining, electroplating and punching (microembossing) techniques.

(i) Laser Micromachining

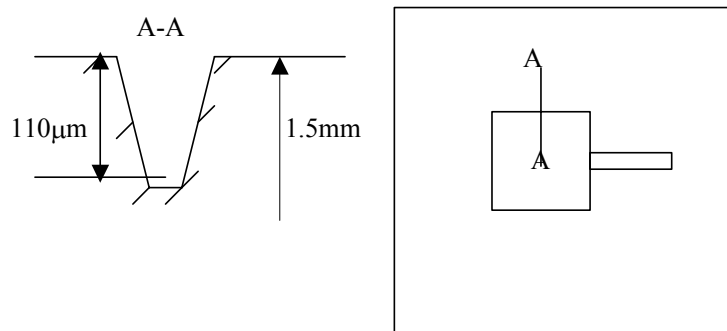


Figure 2 - Cross Section and Profile of the Channel on Polycarbonate

In order to fabricate the cantilever, the required shape has been machined into a polycarbonate substrate using a Nd:YAG laser. A channel with profile shown in Fig 2 has been ablated on a polycarbonate substrate with dimensions $100\text{mm} \times 100\text{mm} \times 1.5\text{mm}$ by using a 355nm laser. Typical machining conditions used in this work are 80% of Diode power, 10 kHz frequency at 10 shots. As it is well known that it is difficult to obtain vertical walls using the laser machining, the top and bottom dimensions of the

fabricated structure are different. In this case, the width of the feature at the bottom and top are $20\mu\text{m}$ and $65\mu\text{m}$ respectively, with an approximate depth of $110\text{-}120\mu\text{m}$.

(ii) *Electroplating Nickel Shim*

A nickel shim was electroplated on to the polycarbonate substrate with ablated channel (Figure 3). Before electroplating, a layer of silver was sprayed on the surface of polycarbonate as a contact layer. Then polycarbonate substrate was fixed onto a frame and plated. By controlling the time and current, a nickel shim around $300\mu\text{m}$ thick is electroformed. The top and bottom widths of the electroformed Nickel structures are $16\mu\text{m}$ and $65\mu\text{m}$ respectively.

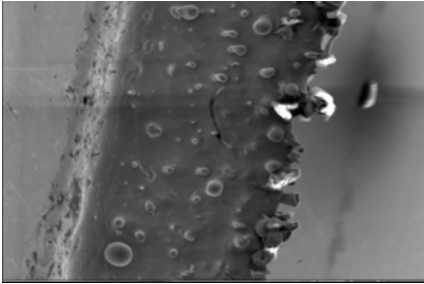


Figure 3 - SEM image of Nickel Shim

(iii) *Punching the PVDF cantilever*

Punching of the PVDF beam has been made on the embossing machine at the room temperature. The procedure used for this purpose is similar to the embossing technique described elsewhere (Telgarsky M). The shim, PVDF film and the insert are fixed in a sandwich structure shown in Figure 4.

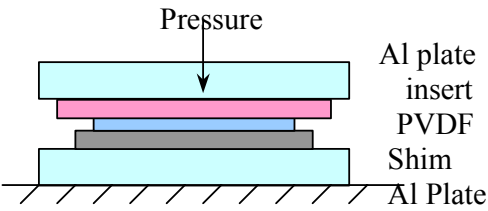


Figure 4 - Punching Process

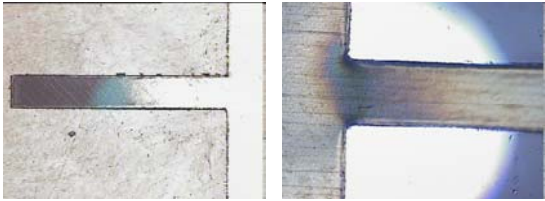


Figure 5 - Piezoelectric Polymer Cantilever

6. Conclusions

This work demonstrated the design and fabrication of a piezoelectric cantilever beam. Simulation and modelling tools were used to optimise the parameters of the beam and visualise the beam bending and stress distribution. Piezoelectric unimorph cantilever was fabricated by laser micromachining, electroplating and punching techniques. Therefore this route appears to be a promising way to shape and fabricate polymer films, which are flexible and sensitive to temperature. The non-piezoelectric metal layer can be electroplated on the metallised PVDF to form a composite piezoelectric cantilever beam.

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8. References

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